

## Advance Technical Information

# PolarP2<sup>™</sup> Power MOSFET

# **IXTQ470P2**

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode



$\mathbf{V}_{\mathtt{DSS}}$	=	500V
   <sub>D25</sub>	=	42A
R <sub>DS(on)</sub>	≤	145m $\Omega$
t <sub>rr(typ)</sub>	=	400ns

Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	500	V	
V <sub>DGR</sub>	$T_J = 25^{\circ}\text{C to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	500		
V <sub>GSS</sub>	Continuous	± 30	V	
V <sub>GSM</sub>	Transient	± 40		
I <sub>D25</sub>	$T_{\rm c} = 25^{\circ}{\rm C}$	42	A	
	$T_{\rm c} = 25^{\circ}{\rm C}$ , Pulse Width Limited by $T_{\rm JM}$	126	A	
I <sub>A</sub>	$T_c = 25^{\circ}C$	42	A	
E <sub>AS</sub>	$T_c = 25^{\circ}C$	1.3	J	
dv/dt	$I_{_{S}} \le I_{_{DM}}, \ V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 150^{\circ}C$	10	V/ns	
$P_{D}$	T <sub>c</sub> = 25°C	830	W	
T <sub>J</sub>		-55 +150	°C	
T <sub>JM</sub>		150	°C	
T <sub>stg</sub>		-55 +150	°C	
T <sub>L</sub>	Maximum Lead Temperature for Soldering Plastic Body for 10s	300	°C	
T <sub>SOLD</sub>		260	°C	
M <sub>d</sub>	Mounting Torque	1.13/10	Nm/lb.in.	
Weight		5.5	g	

10-38			
		0	
	G D S	1	
	_	Tab	

G = Gate	D	=	Drain
S = Source	Tab	=	Drain

## **Features**

- Avalanche Rated
- Fast Intrinsic Diode
- Dynamic dv/dt Rated
- Low Package Inductance

## **Advantages**

- High Power Density
- Easy to Mount
- Space Savings

## **Applications**

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls

SymbolTest ConditionsChara(T, = 25°C, Unless Otherwise Specified)Min.		cteristic	Values Max.		
BV <sub>DSS</sub>	$V_{GS} = 0V, I_{D} = 250\mu A$	500	. , , ,		V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250\mu A$	2.5		4.5	V
I <sub>gss</sub>	$V_{GS} = \pm 30V, V_{DS} = 0V$			± 100	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$			5	μΑ
	T <sub>J</sub> = 125°C			50	μΑ
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$			145	$m\Omega$



Symbol Test Conditions Cha		Char	racteristic Values		
$(T_J = 25^{\circ}C U$	nless Otherwise Specified)	Min.	Тур.	Max.	
<b>g</b> <sub>fs</sub>	$V_{DS} = 20V, I_{D} = 0.5 \bullet I_{D25}, Note 1$	23	36	S	
C <sub>iss</sub>			5400	pF	
C <sub>oss</sub>	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		545	pF	
C <sub>rss</sub>			44	pF	
t <sub>d(on)</sub>	Resistive Switching Times		23	ns	
t <sub>r</sub>	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		12	ns	
t <sub>d(off)</sub>	00 00 00 0		42	ns	
t <sub>f</sub>	$R_{\rm G} = 3\Omega$ (External)		9	ns	
$Q_{g(on)}$			88	nC	
Q <sub>gs</sub>	$V_{GS} = 10V$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_{D} = 0.5 \cdot I_{D25}$		30	nC	
$Q_{gd}$			31	nC	
R <sub>thJC</sub>				0.15 °C/W	
R <sub>thCS</sub>			0.25	°C/W	

# TO-3P (IXTQ) Outline Fins: 1 - Gate 2 - Drain 3 - Source 4 - Drain SYM INCHES MILLIMETERS MIN MAX MIN MAX A .185 193 4.70 4.90 A1 .051 .059 1.30 1.50 A2 .057 .065 1.45 1.65 b .035 .045 0.90 1.15 b2 .075 .087 1.90 2.20 b4 .114 .126 2.90 3.20 c .022 .031 0.55 0.80 D .780 .791 19.80 20.10 D1 .665 .677 16.90 17.20 E .610 .622 15.50 15.80 E1 .531 .539 13.50 13.70 e .215 8SC 5.45 8SC L .779 .795 19.80 20.20 L1 .134 .142 3.40 3.60 ØP .126 .134 3.20 3.40 ØP .1272 .280 6.90 7.10 S .193 .201 4.90 5.10 All metal area are tin plated.

### Source-Drain Diode

Symbol Test Conditions		Characteristic Values			
$(T_J = 25^{\circ}C U$	nless Otherwise Specified)	Min.	Тур.	Max.	
I <sub>s</sub>	$V_{GS} = 0V$			42	Α
I <sub>SM</sub>	Repetitive, Pulse Width Limited by $\mathrm{T}_{_{\mathrm{JM}}}$			168	Α
V <sub>SD</sub>	$I_F = I_S$ , $V_{GS} = 0V$ , Note 1			1.5	V
t <sub>rr</sub>	$I_F = 21A$ , -di/dt = 100A/ $\mu$ s		400		ns
	$V_{R} = 100V, V_{GS} = 0V$				

Note 1. Pulse test,  $t \le 300\mu s$ , duty cycle,  $d \le 2\%$ .

## **ADVANCE TECHNICAL INFORMATION**

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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